

Features

- Low V_{CE(sat)}
- Fast Switching
- High Ruggedness
- Short-Circuit Rated

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V			1	2	
V		ROF	IS	N	1
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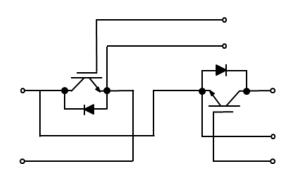
Product Summary				
V _{CES}	1200V			
lc	450A			
V _{CE(sat),typ}	1.55V			



- General Purpose Inverters
- Frequency Converters
- Industrial Motor Drives
- Servos



Internal Connection



• IGBT, Inverter

Absolute Maximum Ratings

Parameter	Symbol	Limit	Unit	
Collector-to-Emitter Voltage	V _{CES}	1200		
Gate-to-Emitter Voltage	N	±20	v	
Transient Gate-emitter Voltage ($t_p \le 10\mu s$, D < 0.010)	V _{GES}	±30		
Continuous DC Collector Current (T _c = 100°C, T _J = 175°C)	I _{CDC}	450		
Repetitive Peak Collector Current (t _p = 1ms)	I _{CRM}	900	A	
Maximum Power Dissipation ($T_c = 25^{\circ}C$, $T_J = 175^{\circ}C$)	P _{D(max)}	2083	W	

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Electrical Characteristics ^{(1), (2)}

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Collector-to-Emitter Breakdown Voltage	BV _{CES}	V _{GE} = 0V, I _C = 250μA	1200	-	-	v
Collector-to-Emitter Leakage Current	I _{CES}	V _{CE} = 1200V, V _{GE} = 0V	-	-	5	mA
Gate-to-Emitter Leakage Current	I _{GES}	$V_{CE} = 0V, V_{GE} = \pm 20V$	-	-	400	nA
Gate Threshold Voltage	V _{GE(th)}	$V_{CE} = V_{GE}$, $I_C = 1.5 mA$	4.8	6	7.2	
		V _{GE} = 15V, I _C = 450A	-	1.55	1.95	
		V _{GE} = 15V, I _C = 450A,		1.0		v
Collector-to-Emitter Saturation Voltage	$V_{CE(sat)}$	T _J = 150°C	-	1.9	-	
		V _{GE} = 15V, I _C = 450A, T _J = 175°C	-	2.0	-	
Total Gate Charge	Qg	$V_{CC} = 600V,$ $V_{GE} = \pm 15V,$ $I_{C} = 450A$	-	4.32	-	μC
Internal Gate Resistance	R _{Gint}	-	-	1	-	Ω
Input Capacitance	C _{iss}	V _{CE} = 25V,	-	29.2	-	nF
Output Capacitance	Coss	V _{GE} = 0V,	-	2.03	-	
Reverse Transfer Capacitance	C _{rss}	f = 1MHz	-	0.39	-	
Turn-on Delay time	t _{d(ON)}		-	680	-	ns
Rise Time	t _r	V _{cc} = 600V,	-	87	-	
Turn-off Delay time	t _{d(OFF)}	$V_{GE} = \pm 15V,$ $R_G = 2.2\Omega,$	-	513	-	
Fall Time	t _f	I _C = 450A, L _{load} = 0.82mH,	-	192	-	
Turn-On Switching Loss	E _{on}	Energy losses include	-	19.1	-	
Turn-Off Switching Loss	E _{off}	"tail" and diode reverse recovery.	-	40.1	-	mJ
IGBT Total Switching Loss	E _{ts}		-	59.2	-	
Turn-on Delay time	t _{d(ON)}		-	703	-	
Rise Time	tr	$V_{CC} = 600V,$ $V_{GE} = \pm 15V,$	-	98	-	
Turn-off Delay time	t _{d(OFF)}	R _G = 2.2Ω, I _C = 450A,	-	612	-	ns
Fall Time	t _f	$L_{load} = 0.82 mH$,	-	363	-	
Turn-On Switching Loss	Eon	Energy losses include "tail" and diode reverse	-	32.3	-	
Turn-Off Switching Loss	E _{off}	recovery. TJ = 150°C	-	67.1	-	mJ
IGBT Total Switching Loss	E _{ts}		-	99.4	-	
Short Circuit Collector Current	I _{C(SC)}	V_{GE} = 15V, $V_{CC} \le 600V$, $t_{SC} \le 10\mu s$	-	1800	-	A

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• Diode, Inverter

Absolute Maximum Ratings

Parameter	Symbol	Limit	Unit
Repetitive Peak Reverse Voltage	V _{RRM}	1200	V
Continuous DC Forward Current	IF	450	٨
Repetitive Peak Forward Current (t _p = 1ms)	I _{FRM}	900	А

Electrical Characteristics (1)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Diode Forward Voltage	I _F = 450A	-	1.95	2.35		
	V _F	I _F = 450A T _J = 150°C	-	2.1	-	v
		I _F = 450A T _J = 175°C	_ 2.15	-		
Diode Reverse-Recovery Charge	Q _{rr}		-	17	-	μC
Diode Peak Reverse-Recovery Current		V _R = 600V, I _F = 450A, dI _F /dt = - 2700 A/μs	-	155	-	А
Diode Reverse-Recovery Loss	Err		-	5.6	-	mJ

<u>Module</u>

Absolute Maximum Ratings

Parameter	Symbol	Limit	Unit
Maximum Junction Temperature	Tj	-40 to +175	
Operating Junction Temperature	T _{vj op}	-40 to +150	°C
Storage Temperature	T _{stg}	-40 to +125	
Isolation Voltage (RMS, f = 50Hz, t = 1min)	V _{ISO}	4.0	kV

Characteristics

Parameter	Symbol	Min	Тур	Max	Unit
Material of Module Baseplate	-	-	Cu	-	-
Internal Isolation	-	-	Al ₂ O ₃	-	-
Creepage Distance, Terminal to Heatsink	-	-	29	-	mm
Creepage Distance, Terminal to Terminal	-	-	23	-	mm
Clearance, Terminal to Heatsink	-	-	23	-	mm
Clearance, Terminal to Terminal	-	-	11	-	mm

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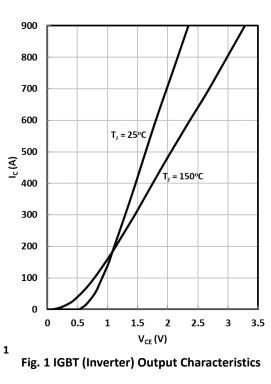
Stray Inductance, Module	Lee	_	20	_	nH
	L _{SCE}	-	20	-	1111
Module Lead Resistance, Terminal to Chip	R _{CC'+EE'}	-	0.7	-	mΩ
Junction-to-Case Thermal Resistance, per IGBT, Inverter			0.06	-	20 (11)
Junction-to-Case Thermal Resistance, per Diode, Inverter	R _{θJC}	-	0.1	-	°C/W
Case-to-Heatsink Thermal Resistance, per IGBT, Inverter		-	0.034	-	°C/W
Case-to-Heatsink Thermal Resistance, per Diode, Inverter	$R_{\theta CH}$	-	0.05	-	
Case-to-Heatsink Thermal Resistance, per Module		-	0.01	-	
Mounting Torque for Module Mounting, Screw M6	М	3.0	-	6.0	Nm
Terminal Connection Torque, Screw M6	М	2.5	-	5.0	Nm
Weight per Module	G	-	320	-	g

(1) $T_J = 25^{\circ}C$ unless otherwise specified

(2) $t_r:$ from 10% of Ic to 90% of Ic; $t_f:$ from 90% of Ic to 10% of Ic;

 $E_{on}:$ from 10% of V_{GE} to 10% of $V_{CE};~~E_{off}:$ from 90% of V_{GE} to 10% of Ic.





Typical Electrical Characteristics

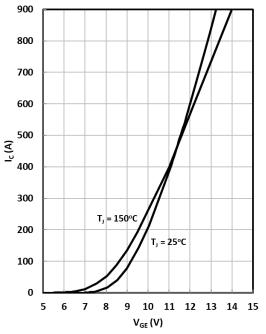
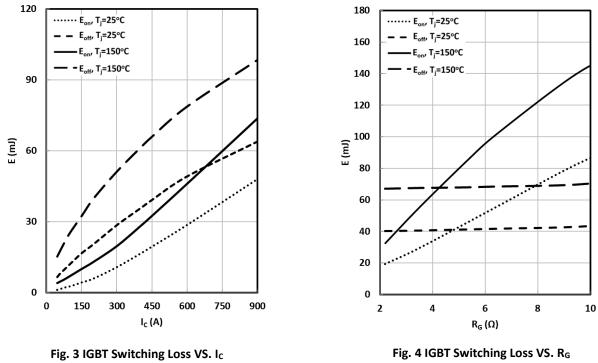


Fig. 2 IGBT (Inverter) Transfer Characteristics

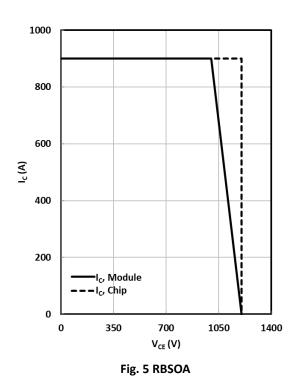


 $(V_{CC} = 600V, V_{GE} = \pm 15V, I_c = 450A)$

(V_{CC} = 600V, V_{GE} = ± 15 V, R_g = 2.2 Ω)

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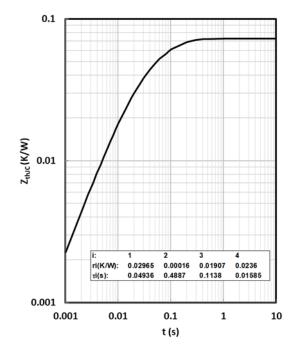


Fig. 6 IGBT (Inverter) Transient Thermal Impedance

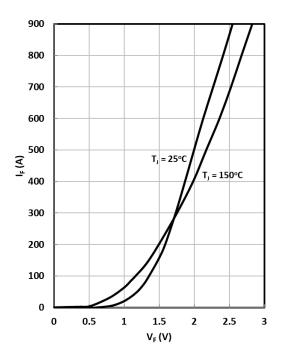
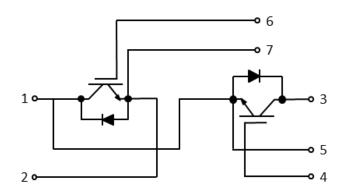


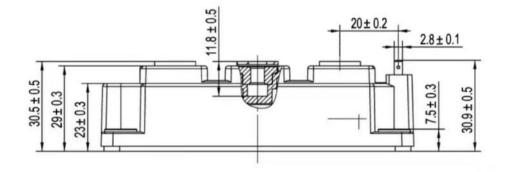
Fig. 7 Diode (Inverter) Forward Characteristics

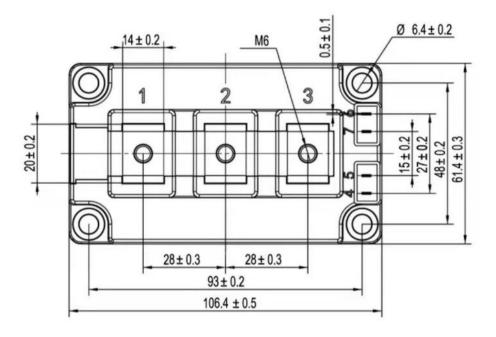


• <u>Circuit diagram</u>



Package Dimensions





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